

The PDSP16330 is a high speed digital CMOS IC that converts Cartesian data (Real and Imaginary) into Polar form (Magnitude and Phase), at rates up to 10MHz. Cartesian 16+16 bit 2's complement or Sign-Magnitude data is converted into 16 bit Phase format. The Magnitude output may be scaled in amplitude by powers of 2. The Phase output represents a full $2 \times \pi$ field to eliminate phase ambiguities.

Polyimide is used as an inter-layer dielectric and as glassivation.

FEATURES

- 10MHz Cartesian to Polar Conversion
- 16-Bit Cartesian Inputs
- 16-Bit Magnitude Output
- 12-Bit Phase Output
- 2's Complement or Sign-Magnitude Input Formats
- Three-state Outputs and Independent Data Enables Simplify System Interfacing
- Magnitude Scaling Facility with Overflow Flag
- Less than 400 mW Power Dissipation at 10MHz
- 100 pin CQFP Package

APPLICATIONS

- Digital Signal Processing
- Digital Radio
- Radar Processing
- Sonar Processing
- Robotics

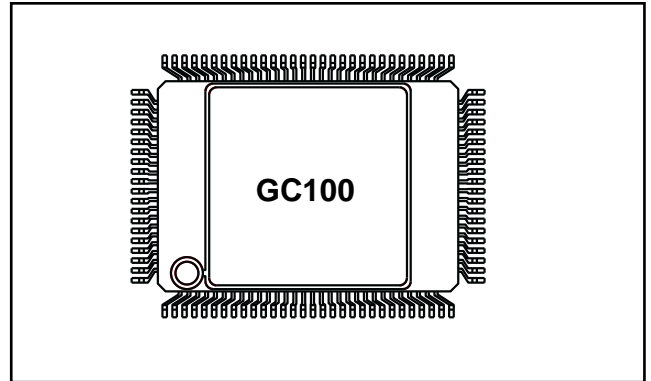


Fig.1 Pin connections - QFP Package

Rev	A	B	C	D
Date	FEB 1992	MAR 1993	OCT 1995	NOV 1998

ASSOCIATED PRODUCTS

- PDSP16112** 16 X 12 Complex Multiplier
- PDSP16116** 16 X 16 Complex Multiplier
- PDSP16318** Complex Accumulator
- PDSP16350** I/Q Splitter and NCO
- PDSP16510A** Stand Alone FFT Processor

ORDERING INFORMATION

PDSP16330/MC/GC1R (10MHz - QFP Package, MIL-STD-883 Screening)

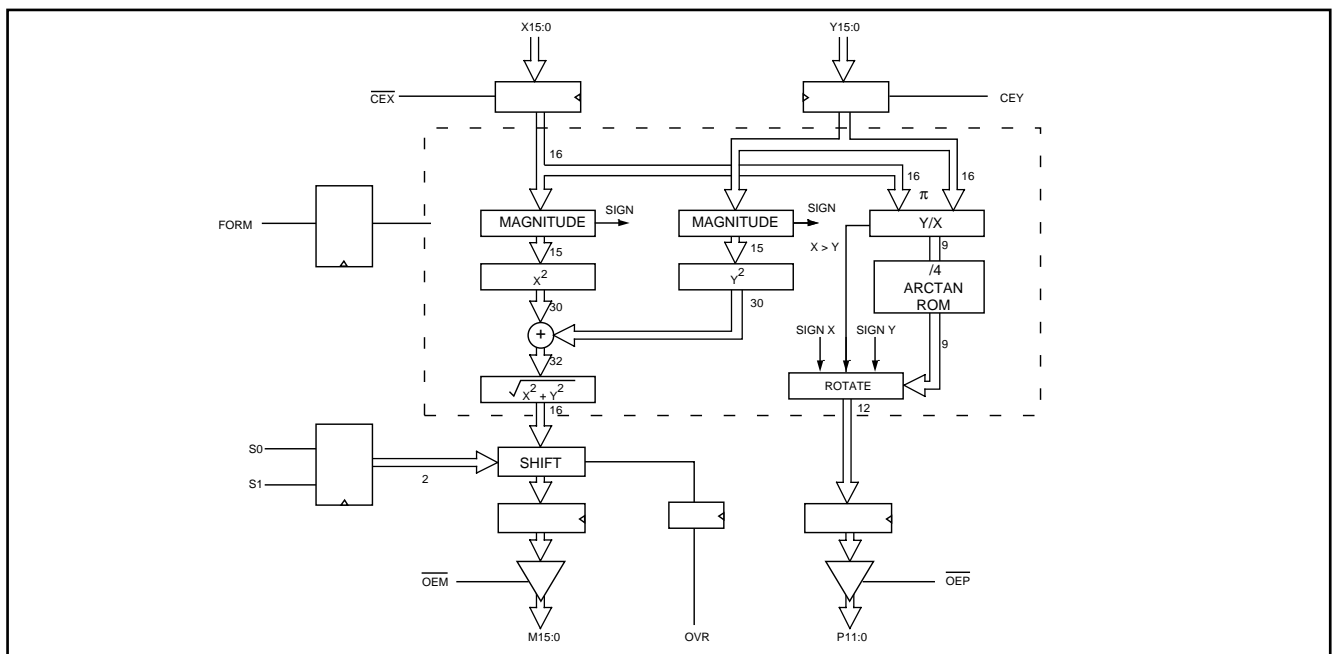


Fig.2 Block diagram

PDSP16330 MC

FUNCTIONAL DESCRIPTION

The PDSP16330 converts incoming Cartesian Data into the equivalent Polar Values. The device accepts new 16 + 16 bit complex data every cycle, and delivers a 16 bit + 12 bit Polar equivalent after 24 clock cycles. The input data can be in 2s' Complement or Sign Magnitude format selected via the FORM input. The output is in a magnitude format for both the Magnitude output and the Phase. Phase data is zero for data with a zero Y input and positive X, and is 400 hex for zero X data and positive Y, is 800 hex for zero Y data and negative X, and is C00 hex for zero X and negative Y. The LSB weighting (bit 0) is $2 \times \pi / 4096$ radians. The 16 bit Magnitude result may be scaled by shifting one, two, or three places in the more significant direction, effectively multiplying the Magnitude result by 2, 4 or 8 respectively. Any of these shifts can under certain conditions cause an invalid result to be output from the device. Under these circumstances the OVR output will become active. The PDSP16330 has independent clock enables and three state output controls for all ports.

FORM

This input selects the format of the X and Y input data. A low level on FORM indicates that the Input data is twos' complement format (Note: input data 8000 hex is not valid in 2s' complement mode). This input refers to the format of the current Input data and may be changed on a per cycle basis if desired. The level of FORM is latched at the same time as the data to which it refers.

S1-0

These inputs select the scaling factor to be applied to the Magnitude output. They are latched by the rising edge of CLK and determine the scaling of the output in the cycle after they are loaded into the device. The scale factor applied is determined by the table. Should the scaling factor applied cause an invalid Magnitude result to be output on the M Port, then the OVR Flag will become active for the period that the M Port output is invalid.

S1	S0	Scaling Factor
0	0	x1
0	1	x2
1	0	x4
1	1	x8

The output number range is from 0 to 2 when the scaling factor is set at x1.

PIN DESCRIPTIONS

Symbol	Pin Name and Description
CLK	Clock: Common Clock to device Registers. Register contents change on the rising edge of clock. Both pins must be connected.
$\overline{CE}X$	Clock Enable: Clock Enable for X Port. The clock to the X port is enabled by a low level.
$\overline{CE}Y$	Clock Enable: Clock Enable for Y Port The clock to the Y port is enabled by a low level.
X15-X0	X Data Input Data presented to this input is loaded into the device by the rising edge of CLK. X15 is the MSB
Y15-Y0	Y Data Input Data presented to this input is loaded into the device by the rising edge of CLK. Y15 is the MSB
M15-M0	M Data Output: Magnitude data generated by the device is output on this port. Data changes on the rising edge of CLK, M15 is the MSB. The weighting of M15 is determined by the Scale factor selected .
P11-P0	P Data Output: Phase data generated by the device is output on this port. Data changes on the rising edge of CLK, P11 is the MSB. The weighting of P11 is π radians.
$\overline{OE}M$	Output Enable: Output Enable for M Port. The M Port is in a high impedance state when this input is high.
$\overline{OE}P$	Output Enable: Output Enable for P Port. The P Port is in a high impedance state when this input is high.
FORM	Format Select This input selects the format of the Cartesian Data input on the X and Y ports. This input is latched by the rising edge of CLK, and is applied at the same time as the data to which it refers. A low level indicates that two's complement data is applied, a high indicates Sign-Magnitude
S1-S0	Scaling Control: Control input for scaling of Magnitude Data. This input is latched by the rising edge of CLK, and determines the scaling to be applied to the Magnitude result. The Scaling is applied to the output data in the cycle following the cycle in which the control was latched.
OVR	Overflow: Overflow flag. This signal becomes active if the scaling currently selected causes an invalid value to be presented to the Magnitude output.
Vcc	+5V supply. All Vcc pins must be connected.
GND	0V supply. All GND pins must be connected.

INPUT DATA RANGE

2's Complement	Sign Magnitude
7FFF	7FFF
.	.
.	.
.	.
0001	0001
0000	0000
FFFF	8000
.	.
.	.
.	.
8001	FFF

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PIN FUNCTION

Pin No. GC	Function	Pin No. GC	Function	Pin No. GC	Function
91	M7	23	YO	59	X1
92	M6	24	$\overline{\text{CEY}}$	60	X2
93	M5	25	CLK	61	X3
94	M4	26	V _{cc}	62	X4
95	M3	31	GND	63	X5
96	M2	32	GND	64	X6
97	M1	33	GND	65	X7
98	M0	34	GND	66	X8
99	S0	35	GND	67	X9
100	S1	36	GND	68	X10
1	GND	37	GND	69	X11
6	V _{cc}	38	$\overline{\text{OEP}}$	70	X12
7	FORM	39	P0	71	X13
8	Y15	40	P1	72	X14
9	Y14	41	P2	73	X15
10	Y13	42	P3	74	CLK
11	Y12	43	P4	75	OVR
12	Y11	44	P5	76	V _{cc}
13	Y10	45	P6	81	GND
14	Y9	46	P7	82	$\overline{\text{OEM}}$
15	Y8	47	P8	83	M15
16	Y7	48	P9	84	M14
17	Y6	49	P10	85	M13
18	Y5	50	P11	86	M12
19	Y4	51	GND	87	M11
20	Y3	52	V _{cc}	88	M10
21	Y2	57	$\overline{\text{CEX}}$	89	M9
22	Y1	58	X0	90	M8

ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated): T_{amb} (Military) = -55°C to + 125°C
V_{cc} (Military) = 5.0V ± 10%, GND = 0V

STATIC CHARACTERISTICS

Characteristic	Symbol	Value			Units	Sub-group	Conditions
		Min.	Typ.	Max.			
* Output high voltage	V _{OH}	2.4			V	1,2,3	IOH = 3.2mA IOL = -3.2mA
* Output low voltage	V _{OL}			0.6	V	1,2,3	
* Input high voltage (CMOS)	V _{IH}	3.0			V	1,2,3	Inputs $\overline{\text{CEX}}$, $\overline{\text{CEY}}$ and CLK only Inputs CEX, CEY and CLK only
* Input low voltage (CMOS)	V _{IL}			1.0	V	1,2,3	
* Input high voltage (TTL)	V _{IH}	2.2			V	1,2,3	All other inputs
* Input low voltage (TTL)	V _{IL}			0.8	V	1,2,3	
* Input leakage current (Note 1)	I _{IL}	-10		+ 120	μA	1,2,3	GND ≤ V _{IN} ≤ V _{CC}
† Input capacitance	C _{IN}		10		pF		
* Output leakage current	I _{oz}	-50		+ 50	μA	1,2,3	GND ≤ V _{IN} ≤ V _{CC} V _{cc} = Max
† Output SC current	I _{OS}	-50		230	mA		

NOTES

1. All inputs except clock inputs have high value pull-down resistors
2. All parameters marked * are tested during production. Parameters marked † are guaranteed by design and characterisation.

SWITCHING CHARACTERISTICS

Characteristic	Value		Units	Sub-group	Conditions
	PDSP16330				
	Min.	Max.			
† Input data setup to clock rising edge	15		ns		
† Input data Hold after clock rising edge	2		ns		
† CEX, CEY Setup to clock rising edge	30		ns		
† CEX, CEY Hold after clock rising edge	0		ns		
† FORM, S1:0 Setup to clock rising edge	15		ns		
† FORM, S1:0 Hold after clock rising edge	7		ns		
† Clock rising edge to valid data	5	40	ns		2 x LSTTL + 20pF
* Clock period	100		ns	9,10,11	
† Clock high time	25		ns		
† Clock low time	25		ns		
† Latency	24	24	cycles		
† OEM, OEP low to data high data valid		30	ns		2 x LSTTL + 20pF
† OEM, OEP low to data low data valid		30	ns		2 x LSTTL + 20pF
† OEM, OEP high to data high impedance		30	ns		2 x LSTTL + 20pF
† OEM, OEP low to data high impedance		30	ns		2 x LSTTL + 20pF
† Vcc current (TTL input levels)		110	mA		V _{CC} = Max Outputs unloaded Clock freq. = Max
† Vcc current (CMOS input levels)		70	mA		V _{CC} = Max Outputs unloaded Clock freq. = Max

NOTES

- LSTTL is equivalent to I_{OH} = 20μA, I_{OL} = -0.4mA
- Current is defined as negative into the device
- CMOS input levels are defined as: V_{IH} = V_{DD} - 0.5V, V_{IL} = +0.5V
- All parameters marked * are tested during production.
Parameters marked † are guaranteed by design and characterisation.
- All timings are dependent on silicon speed. This speed is tested by measuring clock period.
This guarantees all other timings by characterisation and design.

ABSOLUTE MAXIMUM RATINGS

Supply voltage, V _{CC}	-0.5V to + 7.0V
Input voltage, V _{IN}	-0.5V to VCC + 0.5V
Output voltage, V _{OUT}	-0.5V to VCC + 0.5V
Clamp diode current per pin, I _K (see Note 2)	±18mA
Static discharge voltage (HMB), V _{STAT}	500V
Storage temperature. T _{stg}	-65°C to + 150°C
Ambient temperature with power applied T _{amb} :	
Military	-55 °C to + 125 °C
Package power dissipation P _{TOT}	1200mW
Junction temperature	150 °C

THERMAL CHARACTERISTICS

Package Type	θ _{JC} °C/W
GC	12

NOTES

- Exceeding these ratings may cause permanent damage. Functional operation under these conditions is not implied.
- Maximum dissipation or 1 second should not be exceeded; only one output to be tested at any one time.
- Exposure to Absolute Maximum Ratings for extended periods may affect device reliability

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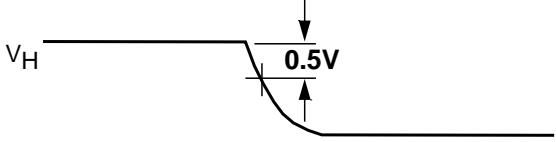
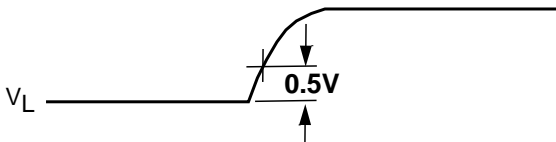
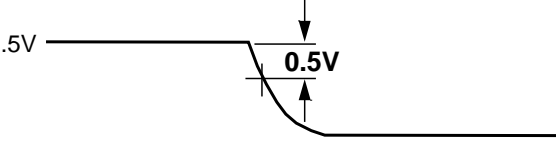
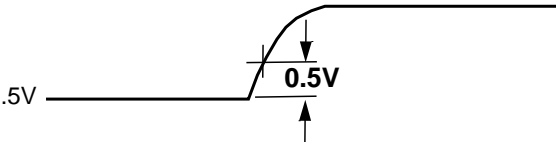
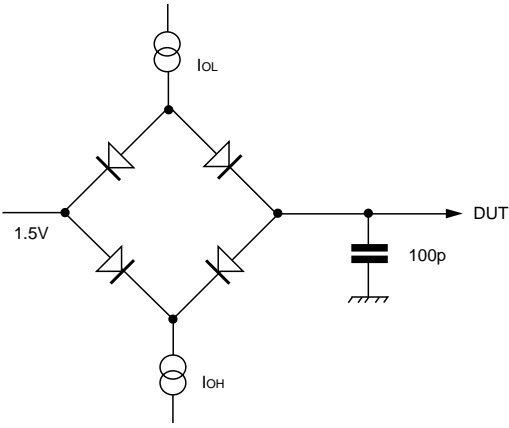
Test	Waveform - measurement level
Delay from output high to output high impedance	
Delay from output low to output high impedance	
Delay from output high impedance to Output low	
Delay from output high impedance to Output high	
<p>NOTES</p> <ol style="list-style-type: none"> V_H - Voltage reached when output driven high V_L - Voltage reached when output driven low <div style="text-align: center;">  </div>	

Fig.2 Three state delay measurement load

PDSP16330 MC

Part No: PDSP16330/A Pythagoras Processor
 Package Type: AC84/GC100

Pin No.4 GC	Con.	Pin No. GC	Con.	Pin No. GC	Con.	Pin No. GC	Con.
76	V1	49	N/C	41	N/C	6	V1
74	V1	84	N/C	37	0v	7	0v
73	0v	82	0v	42	N/C	10	V1
71	0v	70	0v	93	N/C	13	V1
68	0v	66	0v	94	N/C	15	V1
67	0v	65	0v	92	N/C	19	V1
64	0v	50	N/C	40	N/C	22	V1
61	0v	48	N/C	38	0v	25	V1
59	0v	86	N/C	39	N/C	31	0v
58	0v	85	N/C	96	N/C	33	0v
51	0v	47	N/C	97	N/C	1	0v
83	N/C	46	N/C	35	0v	8	V1
81	0v	89	N/C	36	0v	9	V1
75	N/C	88	N/C	98	N/C	11	V1
72	0v	87	N/C	100	V1	14	V1
69	0v	45	N/C	12	V1	20	V1
62	0v	44	N/C	16	V1	18	V1
63	0v	43	N/C	17	V1	21	V1
60	0v	95	N/C	32	0v	23	V1
57	0v	90	N/C	34	0v	24	0v
52	V1	91	N/C	99	V1	26	V1

VDD max = +5.0V = V1

N/C = not connected

(All GC100 pins not specified are N/C)

Fig.3 Life Test/Burn-in connections
 NOTE: PDA is 5% and based on groups 1 and 7



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